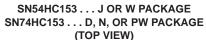
- Permit Multiplexing from n Lines to One Line
- Perform Parallel-to-Serial Conversion
- Strobe (Enable) Line Provided for Cascading (N Lines to n Lines)
- Package Options Include Plastic Small-Outline (D), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

Each of these data selectors/multiplexers contains inverters and drivers to supply full binary decoding data selection to the AND-OR gates. Separate strobe (\overline{G}) inputs are provided for each of the two 4-line sections.

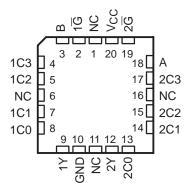
The SN54HC153 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74HC153 is characterized for operation from -40° C to 85°C.

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1 <mark>G</mark> B 1C3	2	∪ ₁₆] V _{CC} 15] 2G
1C3 1C2		14] A 13] 2C3
1C1	5	12 2C2
1C0	6	11 🛛 2C1
1Y	[7	10 2C0
GND	8	9] 2Y

SN54HC153 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

			INPUTS				
SELI	ЕСТ†		DATA				
В	Α	C0	C1	C2	C3	G	
Х	Х	Х	Х	Х	Х	н	L
L	L	L	Х	Х	Х	L	L
L	L	н	Х	Х	Х	L	н
L	Н	Х	L	Х	Х	L	L
L	Н	Х	Н	Х	Х	L	н
н	L	Х	Х	L	Х	L	L
н	L	Х	Х	Н	Х	L	н
н	Н	Х	Х	Х	L	L	L
н	Н	Х	Х	Х	Н	L	н

FUNCTION TABLE

[†]Select inputs A and B are common to both sections.



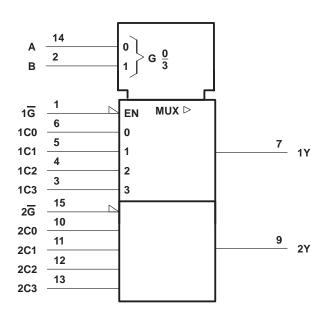
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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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logic symbol[†]

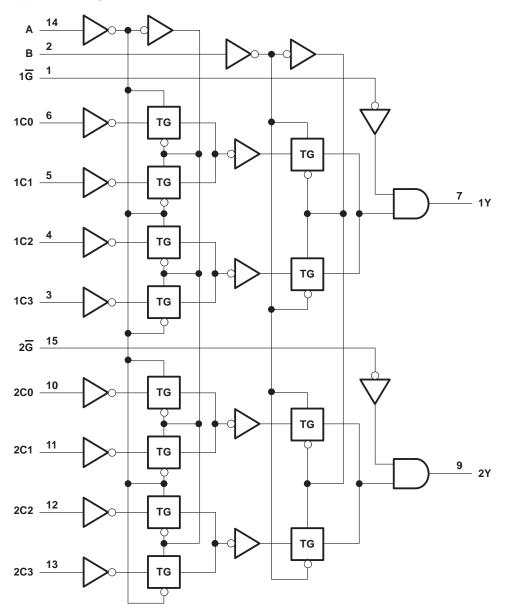


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, N, PW, and W packages.



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logic diagram (positive logic)



Pin numbers shown are for the D, J, N, PW, and W packages.



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absolute maximum ratings over operating free-air temperature range[†]

	e Note 1)	±20 mA ±20 mA ±35 mA ±70 mA 113°C/W 78°C/W
Storage temperature range, T _{stg}	PW package	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

			SN	154HC15	53	SN74HC153		UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	
VCC	Supply voltage		2	5	6	2	5	6	V
		$V_{CC} = 2 V$	1.5			1.5			
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			V
		ACC = 6 A	4.2			4.2			
	Low-level input voltage	V _{CC} = 2 V	0		0.5	0		0.5	
VIL		$V_{CC} = 4.5 V$	0		1.35	0		1.35	V
		ACC = 6 A	0		1.8	0		1.8	
VI	Input voltage		0		VCC	0		VCC	V
Vo	Output voltage		0		VCC	0		VCC	V
		$V_{CC} = 2 V$	0		1000	0		1000	
tt	Input transition (rise and fall) time	$V_{CC} = 4.5 V$	0		500	0		500	ns
		VCC = 6 V	0		400	0		400	
ТА	Operating free-air temperature		-55		125	-40		85	°C



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	NDITIONS	N	Т	A = 25°C	;	SN54H	IC153	SN74H	MAX	UNIT
PARAMETER	TEST CC	INDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	1.9	1.998		1.9		1.9		
		I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4		
∨он	$V_I = V_{IH} \text{ or } V_{IL}$		6 V	5.9	5.999		5.9		5.9		V
		I _{OH} = -6 mA	4.5 V	3.98	4.3		3.7		3.84		
		I _{OH} = -7.8 mA	6 V	5.48	5.8		5.2		5.34		
			2 V		0.002	0.1		0.1		0.1	
		I _{OL} = 20 μA	4.5 V		0.001	0.1		0.1 0. 0.1 0.	0.1		
VOL	$V_I = V_{IH} \text{ or } V_{IL}$		6 V		0.001	0.1		0.1		0.1	V
		I _{OL} = 6 mA	4.5 V		0.17	0.26		0.4		0.33	
		I _{OL} = 7.8 mA	6 V		0.15	0.26		0.4		0.33	
li li	$V_I = V_{CC} \text{ or } 0$		6 V		±0.1	±100		±1000		±1000	nA
ICC	$V_{I} = V_{CC} \text{ or } 0,$	I _O = 0	6 V			8		160		80	μΑ
Ci			2 V to 6 V		3	10		10		10	pF

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM			Т	ן = 25°C	;	SN54H	IC153	SN74H	IC153	UNIT
FARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		90	150		225		190	
	A or B	Y	4.5 V		21	30		45		38	
			6 V		17	26		38		32	
	Data (Any C)	Y	2 V		73	126		189		158	
^t pd			Y	4.5 V		17	28		42		35
	() () ()		6 V		14	23		35	MIN MAX 190 38 32 158 35 29 125 24 20 75		
			2 V		38	95		150		125	
	G	Y	4.5 V		11	19		28		24	
			6 V		9	16		24		20	
			2 V		20	60		90		75	
tt		Y	4.5 V		8	12		18		15	ns
			6 V		6	10		15		13	



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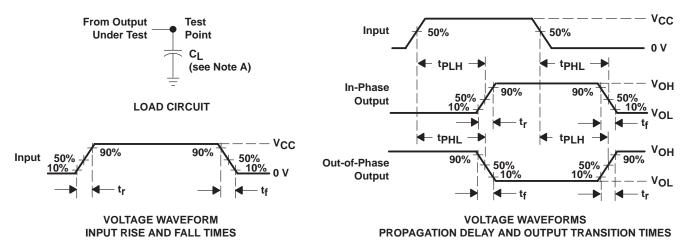
switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	N.	Τ ₄	λ = 25°C	;	SN54H	IC153	SN74H	IC153	UNIT
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		105	235		355		295	
	A or B	Y	4.5 V		27	47		71		59	
			6 V		21	41		60		MAX 295 59 51 274 555 48 230 46 40 265	
	Data (Any C)	Y	2 V		93	220		335		274	
^t pd			Y	4.5 V		23	44		67		55
	(/ (/ (/))		6 V		19	38		57		48	
			2 V		60	19 38 57 48 60 185 280 230					
	G	Y	4.5 V		17	37					
			6 V		14	32		48		40	
		Y	2 V		45	210		315		265	
tt			4.5 V		17	42		63		53	ns
			6 V		13	36		53		45	

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance per multiplexer	No load	40	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. CL includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns.
- C. The outputs are measured one at a time with one input transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms



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